ASSOCIATION CONNECTING ELECTROMICS INDUSTRIES INDUSTRIES	Bannockburn, Illinois.	All rights reserved un ventions.	nder both lev	is docume vel parts, th	ent is a declaration en	n of the substance compasses all lov	es within the manufactur wer level materials for w	er listed item hich the man	n. Note: if t ufacturer h	he item is an as as engineering	sembly with lower responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form T http://www.ipc.org/IPC-175x Distribution				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information							
Supplier Information												
Company name* Company unique ID			Unique I			ue ID Authority			Response Date*			
onsemi	mi							2024-04-19				
Contact Name	t Name Title - Contact			Phone - Contact*				Email - Contact*				
oduct-Env-Stewards Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Representative				Phone - Representative*				Email - Representative*				
Product-Env-Stewards Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item Number	Mfr Item Name			Effective Date	Version	Manufacturing Site		ight*	UOM	Unit Type	
	MC100EP196FAG BBG ECL PRO		DELAY CHIP		2024-04-19		TW2		5.1	mg	Each	
Manufacturing Proccess Information	L	·				•						
Terminal Plating / Grid Array Materia	Iaterial Terminal Base Alloy		-STD-020 MSL R	MSL Rating Peal		eak Process Body Temperature Max Time at Peak		Temperature Number of Reflow Cycles		les		
Matte Tin (Sn) - annealed CU Alloy 2			2		260	С	30	seconds	3			
Comments												
ATTENTION: MSL 2 Rated item requires Dr	y Pack (after electric	al test)										
or more information regarding material com	position please refer	to page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	oHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead b), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl thalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).								
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of				
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted				
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all				
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the orm to have the form returned to the Requester.								
Supplier Digital Signature Ra	stislav Drska	Le							

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.33	mg	Supplier	Silicon (Si)	7440-21-3		0.33	mg
Die Attach 3.1	3.19	mg	Supplier	Silver (Ag)	7440-22-4		2.3925	mg
			Supplier	Epoxy resins	129915-35-1		0.7975	mg
Lead Frame 49.9	49.99	mg	Supplier	Silver (Ag)	7440-22-4		0.15	mg
			Supplier	Magnesium (Mg)	7439-95-4		0.05	mg
			Supplier	Silicon (Si)	7440-21-3		0.3499	mg
			В	Nickel (Ni)	7440-02-0		1.4997	mg
			Supplier	Copper (Cu)	7440-50-8		47.9404	mg
Mold Compound-Black	114.24	mg		Epoxy Phenol Resin	proprietary data		11.9952	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		102.2448	mg
Plating	6.7	mg	Supplier	Tin (Sn)	7440-31-5		6.7	mg
Wire Bond - Au	0.65	mg	Supplier	Gold (Au)	7440-57-5		0.65	mg